

## GENERAL DESCRIPTION

OB5686A is a flyback and buck controller with high power factor, low THD and high constant voltage (CV) precision. It can achieve low system cost for isolated and non-isolated applications.

The proprietary CV control scheme is used and the system can achieve high power factor with constant on-time control scheme. Quasi-resonant (QR) operation and clamping frequency greatly improves the system efficiency. The advanced high voltage start-up technology is used to meet the fast start-up time and low standby power requirements.

OB5686A offers comprehensive protection including line over voltage and line brownout protection, open circuit protection, short circuit protection, over load protection, cycle-by-cycle current limiting, built-in leading edge blanking, VDD under voltage lockout (UVLO), etc.

OB5686A is offered in SOP8 package.

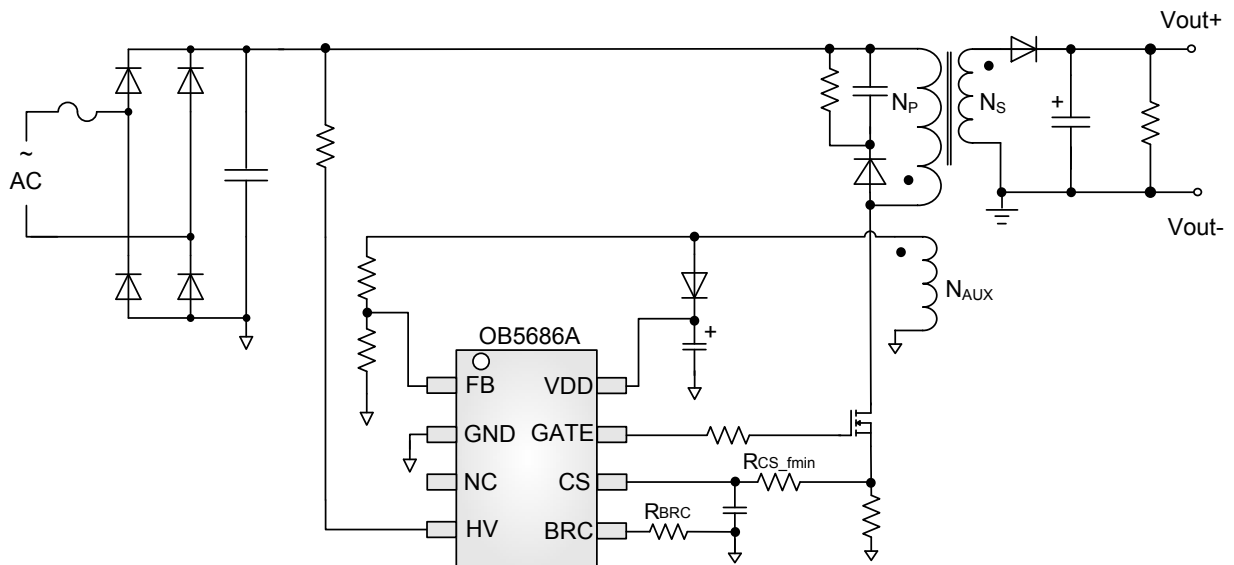
## FEATURES

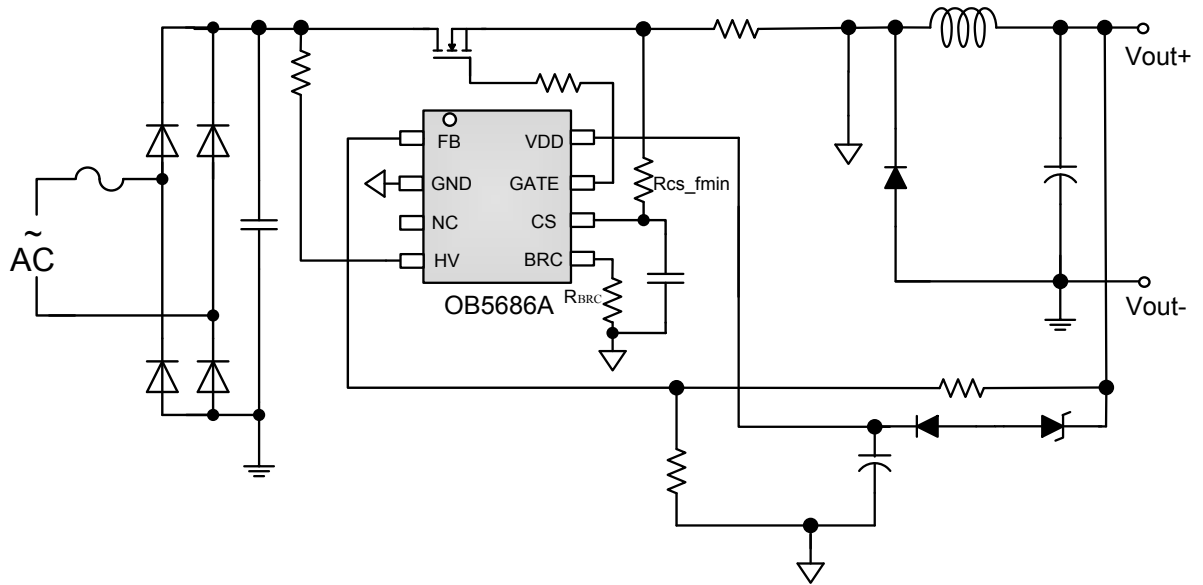
- High precision constant voltage regulation
- High PF and low THD
- HV start-up
- Low Standby Power
- $\pm 5\%/\pm 15\%$  fast dynamic response adaptively
- Externally configurable minimum frequency
- Low system cost and high efficiency
- Quasi-resonant operation
- Externally configurable line brownout protection
- Externally configurable line over voltage protection
- Output short circuit protection
- Output open circuit protection
- Cycle-by-cycle current limiting
- Built-in leading edge blanking (LEB)
- VDD under voltage lockout with hysteresis (UVLO)
- VDD over voltage protection
- Over temperature protection (OTP)
- Over load protection (OLP)
- Audio Noise Free
- Low Standby Power

## APPLICATIONS

- Smart LED lighting
- Motor drive power supply

## FLYBACK TYPICAL APPLICATION

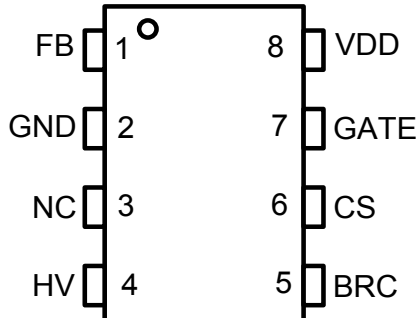


**BUCK TYPICAL APPLICATION**


### GENERAL INFORMATION

#### Pin Configuration

The pin map is shown as below for SOP8.



#### Ordering Information

| Part Number | Description                |
|-------------|----------------------------|
| OB5686ACP   | SOP8, Halogen-free in Tube |
| OB5686ACPA  | SOP8, Halogen-free in T&R  |

**Note:** All Devices are offered in Halogen-free Package if not otherwise noted.

#### Package Dissipation Rating

| Package | R $\theta$ JA (°C/W) |
|---------|----------------------|
| SOP8    | 90                   |

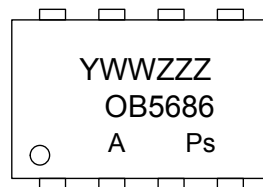
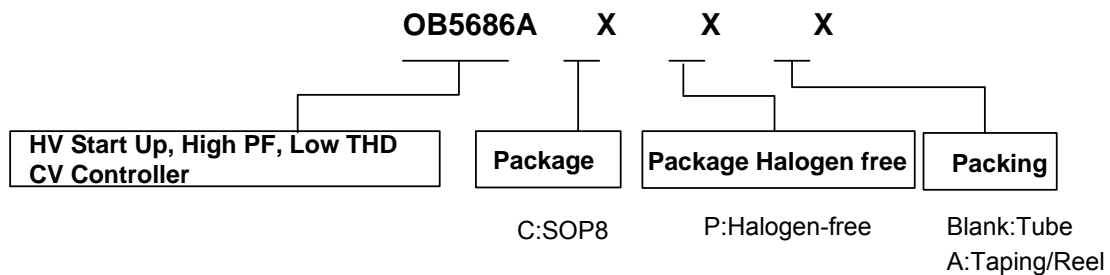
#### Absolute Maximum Ratings

| Parameter   | Value         |
|---|---------------|
| HV Voltage  | -0.3 to 700 V |
| VDD Voltage   | -0.3 to 40V   |
| GATE Voltage  | -0.3 to 40V   |
| CS Input Voltage                                      | -0.3 to 7V    |
| BRC Input Voltage                                     | -0.3 to 7V    |
| FB Input Voltage <sup>2</sup>                         | -1 to 7V      |
| Min/Max Operating Junction Temperature T <sub>J</sub> | -40 to 150 °C |
| Operating Ambient Temperature T <sub>A</sub>          | -20 to 85 °C  |
| Min/Max Storage Temperature T <sub>stg</sub>          | -55 to 150 °C |
| Lead Temperature (Soldering, 10secs)                  | 260 °C        |

**Note1:** Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute maximum-rated conditions for extended periods may affect device reliability.

**Note2:** The negative voltage amplitude is relaxed to -1V under the condition that its max negative current is in less than 10mA.

### Marking Information

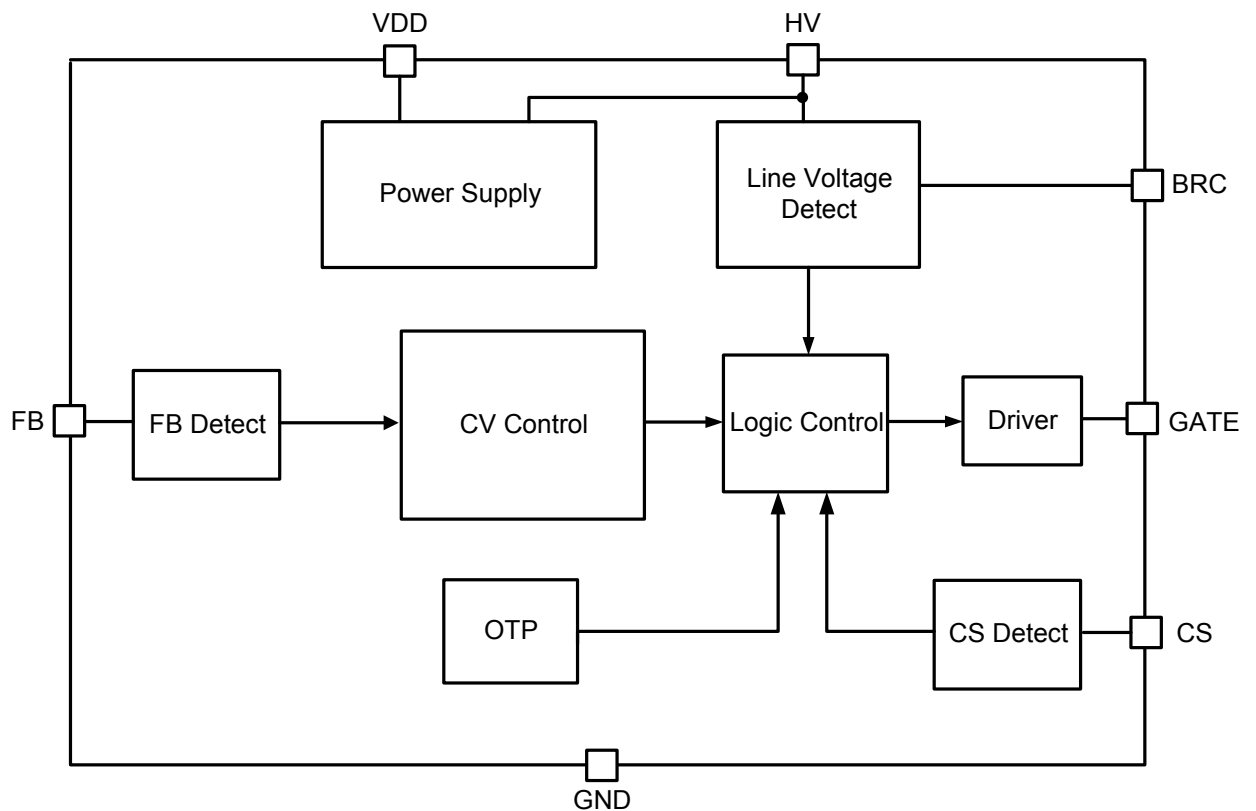


Y:Year Code  
 WW:Week Code(01-52)  
 ZZZ:Lot Code  
 P:Halogen-free Package  
 S:Internal Code(Optional)

## TERMINAL ASSIGNMENTS

| Pin Num | Pin Name | I/O | Description                          |
|---------|----------|-----|--------------------------------------|
| 1       | FB       | I   | Output voltage feedback.             |
| 2       | GND      | P   | Power ground.                        |
| 3       | NC       |     | No connection                        |
| 4       | HV       | P   | High voltage power supply            |
| 5       | BRC      | I/O | Line brownout setting                |
| 6       | CS       | I   | Current sense input pin.             |
| 7       | GATE     | O   | Gate driver output for power MOSFET. |
| 8       | VDD      | P   | Power supply.                        |

## BLOCK DIAGRAM

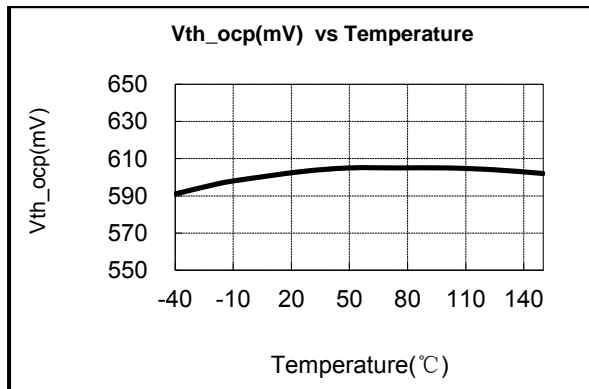
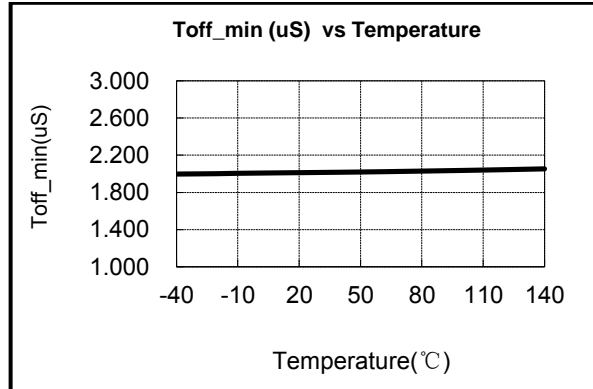
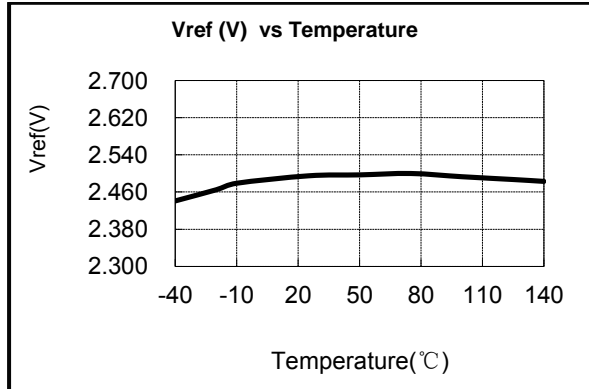
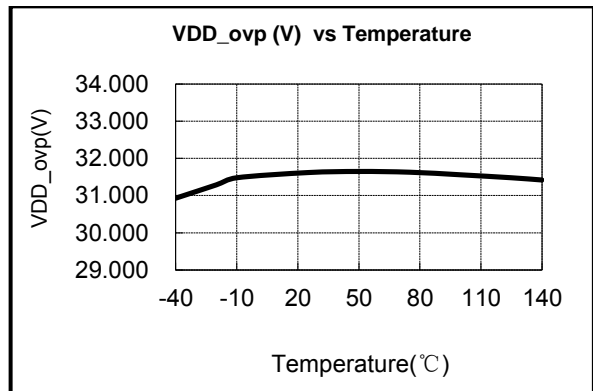
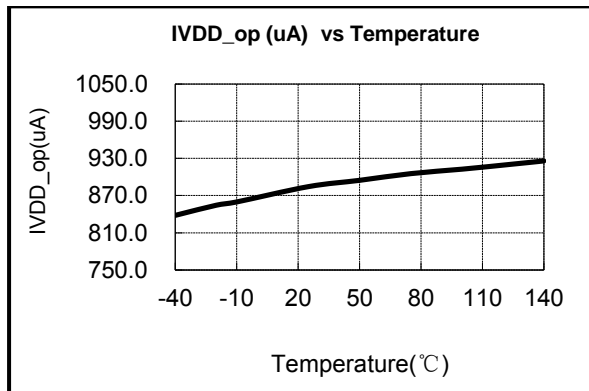
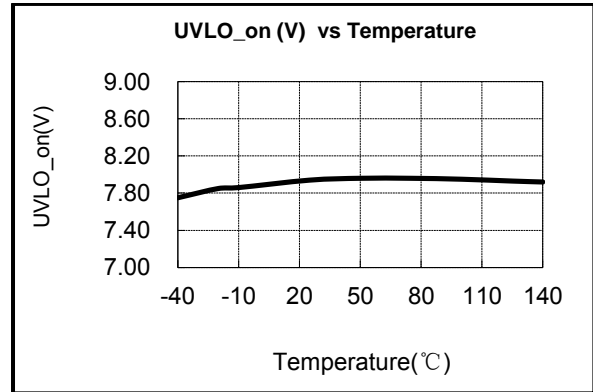
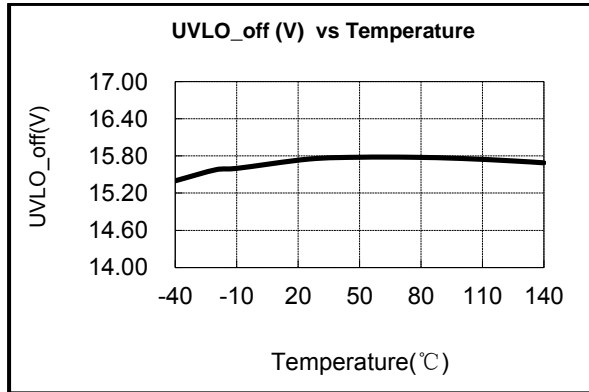


### ELECTRICAL CHARACTERISTICS

(TA = 25°C, VDD=20V, if not otherwise noted)

| Symbol                 | Parameter                                       | Test Conditions           | Min  | Typ. | Max  | Unit |
|------------------------|---|---------------------------|------|------|------|------|
| Supply Voltage Section |   |                           |      |      |      |      |
| IVDD_op                | Static current                                  | VDD=20V                   |      | 850  |      | uA   |
| UVLO_off               | VDD under voltage Lockout Exit                  | VDD rising                |      | 16.2 |      | V    |
| UVLO_on                | VDD under voltage Lockout Enter                 | VDD falling               |      | 8    |      | V    |
| VDD_ovp                | VDD overvoltage protection                      |                           |      | 32   |      | V    |
| FB Detect Section      |   |                           |      |      |      |      |
| Vth_ovp                | Output overvoltage protection                   |                           |      | 3.2  |      | V    |
| Vth_scp                | Output short protection                         |                           |      | 0.4  |      | V    |
| CS Detect Section      |   |                           |      |      |      |      |
| TLEB                   | Leading Edge Blanking time                      |                           |      | 420  |      | ns   |
| Vth_ocp                | Over current threshold voltage                  | Ton=0us                   |      | 0.6  |      | V    |
| CV Control Section     |   |                           |      |      |      |      |
| Vref                   | Error Amplifier Reference Voltage               |                           | 2.45 | 2.5  | 2.55 | V    |
| Fmax                   | Maximum Frequency                               |                           |      | 120  |      | KHz  |
| Toff_min               | Minimum off time                                |                           |      | 2    |      | us   |
| Toff_max               | Maximum off time                                |                           |      | 110  |      | us   |
| Ton_max                | Maximum on time                                 |                           |      | 20   |      | us   |
| Fmin                   | Minimum frequency                               | Rcs_fmin>2.5kohm          |      | 500  |      | Hz   |
|                        |   | Rcs_fmin<1kohm            |      | 500  |      | Hz   |
|                        |   | Rcs_fmin<br>1k~2.5kohm    |      | 1k   |      | Hz   |
| Line Detect Section    |   |                           |      |      |      |      |
| Line_ovp_startup       | Line over voltage protection @ startup          |                           |      | 311  |      | Vac  |
| Line_ovp_normal        | Line over voltage protection @ normal operation |                           |      | 323  |      | Vac  |
| Line_brownout          | Brown-out                                       | R <sub>BRC</sub> =GND     |      | 140  |      | Vac  |
|                        | Brown-in  |                           |      | 154  |      | Vac  |
|                        | Brown-out                                       | R <sub>BRC</sub> Floating |      | 71   |      | Vac  |
|                        | Brown-in  |                           |      | 83   |      | Vac  |
| OTP section            |   |                           |      |      |      |      |
| OTP                    | Over temperature protection                     |                           |      | 150  |      | ℃    |
| Gate Drive Section     |   |                           |      |      |      |      |
| Vclamp                 | Gate output clamping voltage                    |                           |      | 12   |      | V    |
| Tr                     | Rising edge time                                | CL=1nF                    |      | 80   |      | ns   |
| Tf                     | Falling edge time                               | CL=1nF                    |      | 30   |      | ns   |

## CHARACTERIZATION PLOTS



## OPERATION DESCRIPTION

OB5686A is a flyback and buck controller with HV startup high power factor, low THD and high constant voltage (CV) precision. It can achieve low system cost for isolated and non-isolated applications.

### Startup

OB5686A integrates HV startup circuit. During power on state, it provides about 1mA current to charge the capacitor connecting between VDD and ground from HV pin. When the VDD voltage is higher than UVLO\_off, the charge current is switched off. At this moment, the VDD capacitor provides current to OB5686A until the auxiliary winding of the main transformer starts to supply the operation current.

In general application, a 20KΩ(typical) resistor is recommended to be placed in the high voltage path to limit the current.

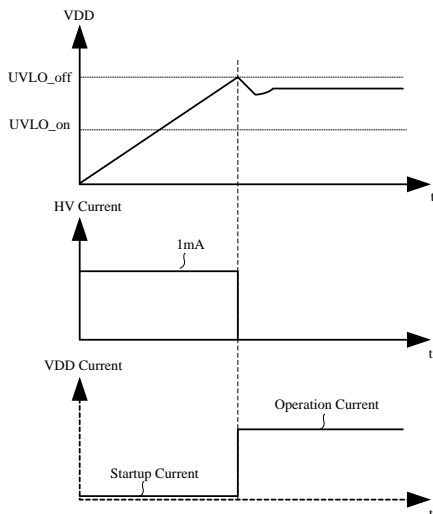


Figure.1 Startup Current Timing

During startup, OB5686A detects the line voltage. If the line voltage is lower than preset brownout voltage for 20mS or is higher than 311Vac, the power MOSFET will not be allowed to turn on. If BRC pin floating, line brownout and line OVP will be disabled. If the line voltage is detected in normal range, OB5686A will operate at open loop and over-current protection is set cycle-by-cycle until it senses the output voltage by FB pin up to about 0.4V.

### Output voltage regulation

In flyback application, in order to achieve primary side constant voltage control, the output voltage is detected through the auxiliary winding voltage. During OFF time, the voltage across the auxiliary winding is:

$$V_A = (V_{OUT} + V_{DF}) \frac{N_A}{N_S}$$

$N_S$  is the turns of secondary winding

$V_{DF}$  is the forward voltage of the power diode

$N_A$  is the turns of auxiliary winding

At the current zero-crossing point,  $V_{DF}$  is nearly zero, so  $V_{OUT}$  is proportional with  $V_A$  exactly. The FB voltage of this point is sampled as the feedback of output voltage. The resistor of voltage divider is designed by:

$$V_{OUT} = \frac{V_{ref}}{\frac{N_A}{N_S} \frac{R_1 + R_2}{R_2}}$$

$V_{ref}$  is the internal voltage reference

$R_1$  is high side resistance of voltage divider

$R_2$  is low side resistance of voltage divider

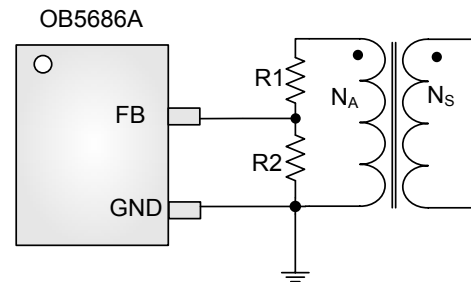


Figure.2 Flyback FB Section Circuit

In buck application, in order to achieve constant voltage control, the output voltage is detected by the buck inductor voltage.

The resistor divider is designed by:

$$V_{OUT} = \frac{V_{ref}}{\frac{R_3 + R_4}{R_4}}$$

$V_{ref}$  is the internal voltage reference

$R_3$  is high side resistance of voltage divider

$R_4$  is low side resistance of voltage divider

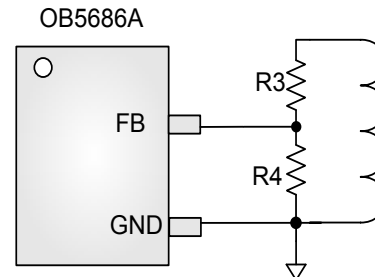


Figure.3 Buck FB Section Circuit

### Adaptively adjust dynamic response

When the output load changes from heavy load to light load, the FB voltage will be detected higher than  $V_{FB\_H}$ , OB5686A is forced into Fmin mode

operation for fast response to reduce the output energy. When the FB voltage returns to VFB\_R, OB5686A works in normal operation. When the output load changes from light load to heavy load, the FB voltage will be detected lower than VFB\_L, OB5686A works in OCP mode for fast response to ensure sufficient energy supply to the output. When the FB voltage returns to VFB\_R, OB5686A works in normal operation.

OB5686A is offered fast dynamic response, the dynamic thresholds VFB\_H and VFB\_L is adjusted adaptively according to the ripple of the output voltage. So OB5686A can internally select different dynamic thresholds for different output capacitors. Also the dynamic threshold can be forced to  $\pm 5\%$  by placing a 2.5k $\Omega$  Rcs\_fmin resistance.

The threshold of VFB as shown in table:

| Dynamic | VFB_H  | VFB_R |
|---------|--------|-------|
| +5%     | 2.625V | 2.55V |
| +15%    | 2.875V | 2.55V |
|         | VFB_L  | VFB_R |
| -5%     | 2.375V | 2.44V |
| -15%    | 2.125V | 2.44V |

### PF and THD

The duration of the turn on period  $t_{on}$  is generated and keeps constant by a patented control method. Constant on time and quasi-resonant operation provide high power factor (PF) and low total harmonic distortion (THD).

### Current Sensing and Leading Edge Blanking

Cycle-by-Cycle current limiting (OCP) is offered in OB5686A. The switching current is detected through the sense resistor between the CS pin and GND. An internal leading edge blanking circuit chops off the sense voltage spike at initial MOSFET on state due to snubber diode reverse recovery. The current limit comparator is disabled during this blanking time and thus the external MOSFET is not closed during this period.

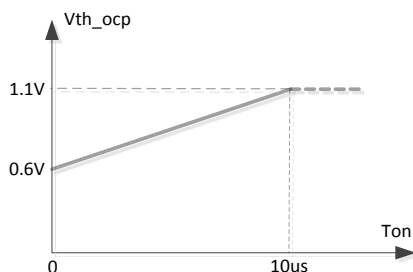


Figure.4 OCP and Ton Curve

### Quasi-Resonant Operation

OB5686A performs quasi-resonant detection through FB pin by monitoring the output voltage. FB voltage drops when the energy stored in transformer or inductance is released to the output. When FB pin voltage falls below 0V (typical), an internal FB comparator is triggered and a new PWM switching cycle is initiated after the FB trigger.

### Gate Drive Output

The output stage is designed to ensure zero cross-conduction current, which minimizes heat dissipation, improves efficiency, and enhances reliability. The built-in 12V clamp at the gate output protects the MOSFET gate from high voltage stress.

### Protection Controls

OB5686A ensures good reliability design through its good protection coverage. Output over voltage protection (OVP), Over Load Protection (OLP), VDD under voltage lockout (UVLO), VDD over voltage protection (VDD OVP), brown-out protection, cycle-by-cycle current limiting, output short circuit protection, output open circuit protection, over temperature protection, line over voltage protection, diode short protection and output gate clamp are standard features provided by OB5686A.

### Short Circuit Protection

When output is shorted, the FB voltage is low. If the voltage at FB pin falls below a threshold of approximately 0.4 V (typical), the OCP threshold voltage is reduced to 0.4 V (typical). In this way, the power dissipation is greatly reduced. OB5686A shuts down during SCP protection, after 0.5S (typical) VDD drops below UVLO\_on and the OB5686A will be reset.

### Open Circuit Protection

When an open circuit happens, the FB pin voltage is high. If the FB pin voltage is higher than a threshold of approximately 3.2V (typical), the IC will shut down and enter power on startup sequence thereafter. The OB5686A shuts down during OCP protection, after 0.5S (typical) VDD drops below UVLO\_on and the OB5686A will be reset.

### Over Load Protection

OB5686A detects output power and offers over load protection (OLP). If output power exceeds the power limit threshold (about 1.3 times of full load), the control circuit reacts by turning off the power MOSFET. The OB5686A shuts down during OLP protection, after 0.5S (typical) VDD drops below UVLO\_on and the OB5686A will be reset.



**Over Temperature Protection**

Over temperature protection is offered in OB5686A. When temperature of the device rises above 150°C (typical), the IC will shut down. And the state will remain until the device is restarted.

**Line Brownout**

Line brownout voltage is set by the BRC pin. When the detected voltage from the BRC reaches the threshold, the line brownout voltage is set before startup. The OB5686A shuts down during line brownout, after 0.5S (typical) VDD drops below UVLO\_on and the OB5686A will be reset. If the BRC pin connecting to GND with 10Kohm resistor, line brownout function will be disabled.

The connecting of the BRC pin as shown in table:

| BRC pin                                | Line Brownout Voltage |
|--|-----------------------|
| Connecting to GND                      | 140Vac                |
| Connecting to GND with 10Kohm resistor | No Brownout           |
| Floating                               | 71Vac                 |

**Line Over Voltage Protection**

OB5686A provides line over voltage protection to prevent IC from working in high voltage stress. OB5686A detects line voltage and compares with inner threshold voltage. When line voltage reaches 323Vac, the over voltage protection function is activated and the switching is turned off, after 0.5S (typical) VDD drops below UVLO\_on and the OB5686A will be reset.

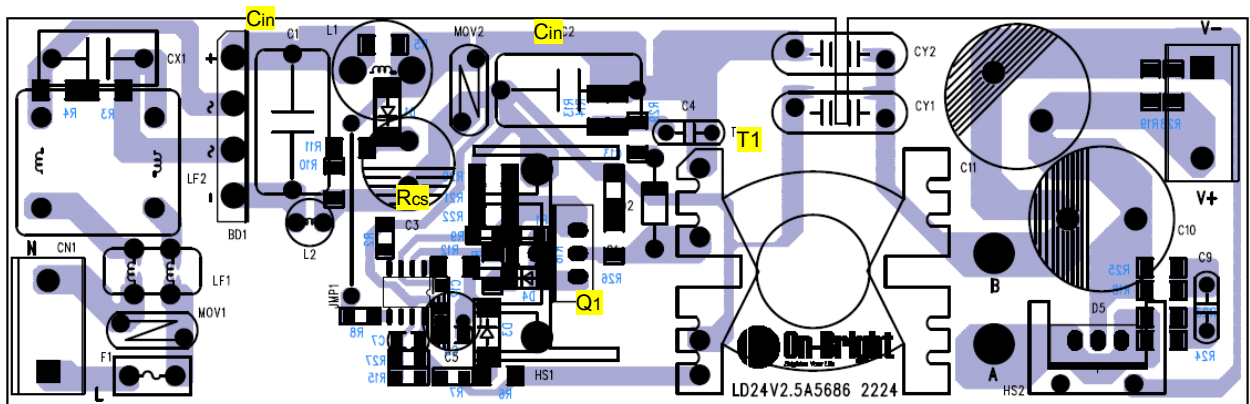
If the BRC pin connecting to GND with 10Kohm resistor, line over voltage protecting function will be disable.

| BRC pin                                | Line OVP Voltage |
|--|------------------|
| Connecting to GND                      | 323Vac           |
| Connecting to GND with 10Kohm resistor | No Line OVP      |
| Floating                               | 323Vac           |

### Layout Consideration

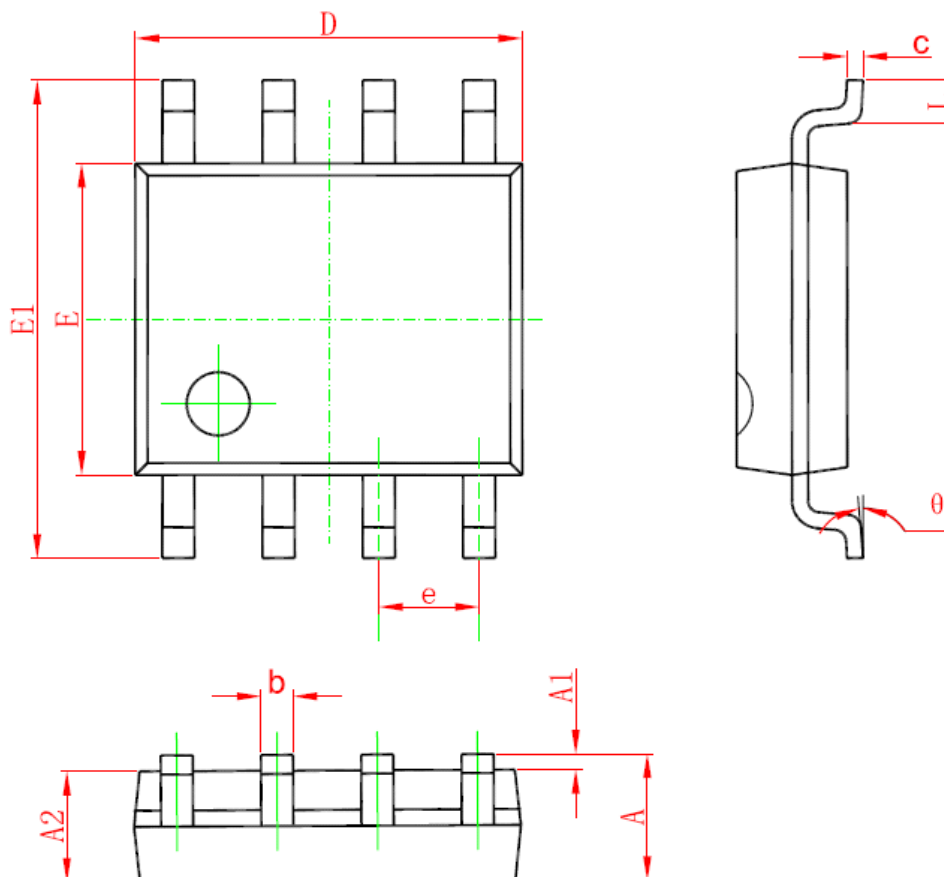
Careful attention must be paid to the PCB board layout and components placement. Proper layout of the high frequency switching path is critical to prevent noise and electromagnetic interference problems. Using the following guidelines for good PCB layout:

- 1) The loop of  $C_{in} \rightarrow T1 \rightarrow Q1 \rightarrow R_{cs} \rightarrow GND$  and  $Gate \rightarrow Q1 \rightarrow R_{cs} \rightarrow GND$  is flowing with high frequency pulse current. They must be as short as possible to decrease noise coupling and kept a space to other low voltage traces, such as IC control circuit paths, especially; Besides, the path between CS resistor ground and IC ground is recommended to be as short as possible, too.
- 2) The loop from the input capacitor to VDD pin is a high voltage loop. Keep a space from the loop to other low voltage traces.
- 3) It is good for reducing noise, output ripple and EMI issue to separate ground traces of the input capacitor, auxiliary winding and IC control circuit. Finally, connect them together at the input capacitor ground. The areas of these ground traces should be kept large.
- 4) Ground of IC peripheral devices should be connected to the IC ground. The ground of CS resistor should be connected with the IC ground first, then tied together at negative pole of the input capacitor.
- 5) To reduce the parasitic trace inductance and EMI, the area of the loop connecting to the secondary winding, the output diode, and the output filter capacitor must be minimized. In addition, the sufficient copper area at the anode and cathode terminal of the output diode can help for heat-sinking. It is recommended to apply the larger area at the quiescent cathode terminal. The large anode area will induce high-frequency radiated EMI.



## PACKAGE MECHANICAL DATA

SOP8



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min                       | Max   | Min                  | Max   |
| A      | 1.350                     | 1.750 | 0.053                | 0.069 |
| A1     | 0.050                     | 0.250 | 0.002                | 0.010 |
| A2     | 1.250                     | 1.650 | 0.049                | 0.065 |
| b      | 0.310                     | 0.510 | 0.012                | 0.020 |
| c      | 0.100                     | 0.250 | 0.004                | 0.010 |
| D      | 4.700                     | 5.150 | 0.185                | 0.203 |
| E      | 3.700                     | 4.100 | 0.146                | 0.161 |
| E1     | 5.800                     | 6.200 | 0.228                | 0.244 |
| e      | 1.270 (BSC)               |       | 0.050 (BSC)          |       |
| L      | 0.400                     | 1.270 | 0.016                | 0.050 |
| θ      | 0°                        | 8°    | 0°                   | 8°    |

## **IMPORTANT NOTICE**

### **RIGHT TO MAKE CHANGES**

On-Bright Electronics Corp. reserves the right to make corrections, modifications, enhancements, improvements and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete.

### **WARRANTY INFORMATION**

On-Bright Electronics Corp. warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with its standard warranty. Testing and other quality control techniques are used to the extent it deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

On-Bright Electronics Corp. assumes no liability for application assistance or customer product design. Customers are responsible for their products and applications using On-Bright's components, data sheet and application notes. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

### **LIFE SUPPORT**

On-Bright Electronics Corp.'s products are not designed to be used as components in devices intended to support or sustain human life. On-bright Electronics Corp. will not be held liable for any damages or claims resulting from the use of its products in medical applications.

### **MILITARY**

On-Bright Electronics Corp.'s products are not designed for use in military applications. On-Bright Electronics Corp. will not be held liable for any damages or claims resulting from the use of its products in military applications.